LNJ311G83RA

Hight Bright Surface Mounting Chip LED

3216 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	55	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	60	mA	
Reverse voltage	V_R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

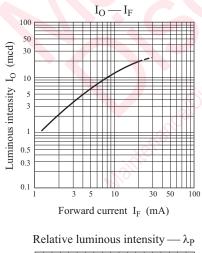
■ Lighting Color

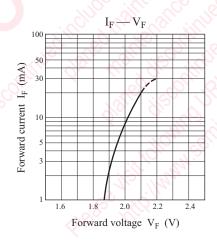
• Yellow Green

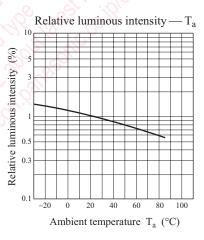
■ Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

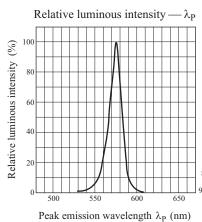
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *	I_{O}	$I_F = 10 \text{ mA}$	0100	6.4	12.0		mcd
Reverse current	I_R	$V_R = 4 V$	igur			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	30, 100		2.03	2.5	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$	MILL SE	_	575	3/10.	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	10 30, ONE 11/03	180	15		nm

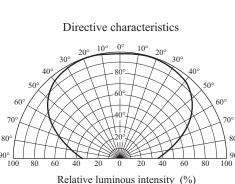
Note) *: Measurement tolerance: ±20%

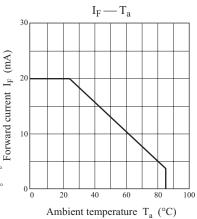










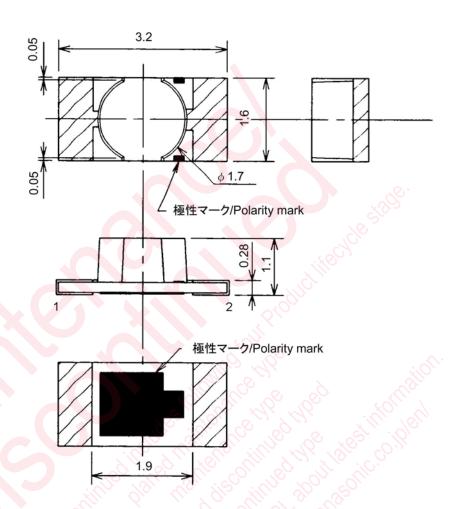


LNJ311G83RA

<u>Panasonic</u>

■ Package (Unit: mm)

KLTFTN2K1100



- Pin name
 - 1: Anode
 - 2: Cathode

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